



Dual N-Channel 100-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$r_{DS(on)}(\Omega)$ I_{D}			
100	0.049 at $V_{GS} = 10 \text{ V}$	5.9		
	0.060 at V _{GS} = 6 V	5.5		

FEATURES

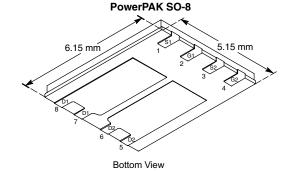
- TrenchFET® Power MOSFET
- New Low Thermal Resistance PowerPAK® Package
- · Dual MOSFET for Space Savings



RoHS*

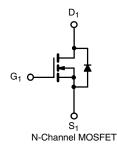
APPLICATIONS

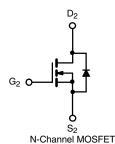
- · Synchronous Buck Shoot-Through Resistant
- · Optimized for Primary Side Switch



Ordering Information: Si7942DP-T1

Si7942DP-T1—E3 (Lead (Pb)-free)





ABSOLUTE MAXIMUM RATINGS	1A - 25 O, unio					
Parameter	Symbol	10 secs	Steady State	Unit		
Drain-Source Voltage		V _{DS}	100		V	
Gate-Source Voltage		V_{GS}	± 20		V	
Continuous Drain Current /T 150 °C\8	T _A = 25 °C	I_	5.9	3.8		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C	ID	4.7	3.0		
Pulsed Drain Current		I _{DM}	20		Α	
Continuous Source Current (Diode Conduction) ^a		I _S	2.9	1.2		
Single Avalanche Current	L = 0.1 mH	I _{AS}	20			
Single Avalanche Energy		E _{AS}		20		
Maniana Banas Birata di ad	T _A = 25 °C	P _D	3.5	1.4	W	
Maximum Power Dissipation ^a	T _A = 70 °C	' D	2.2	0.9	VV	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150 260		°C	
Soldering Recommendations (Peak Temperature)b,c						

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Marrian and Lucation to Amelianta	t ≤ 10 sec	R _{thJA}	26	35	°C/W
Maximum Junction-to-Ambient ^a	Steady State		60	85	
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	2.2	2.7	

Notes

a. Surface Mounted on 1" x 1" FR4 Board.

c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

b. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply.

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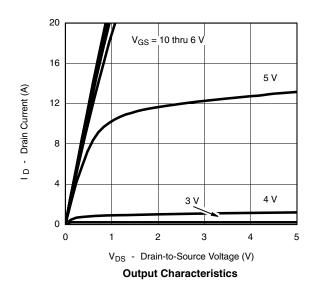


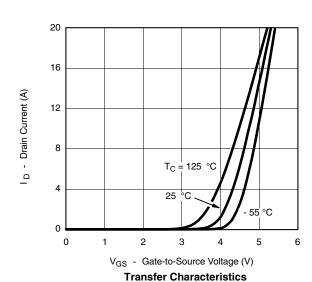
SPECIFICATIONS $T_J = 25$ °C, unless otherwise noted							
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{GS(th)}$ $V_{DS} = V_{GS}$, $I_D = 250 \mu A$			4.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zava Cata Valtaga Dvain Current	I _{DSS}	V _{DS} = 100 V, V _{GS} = 0 V	/		1		
Zero Gate Voltage Drain Current		V _{DS} = 100 V, V _{GS} = 0 V, T _J = 55 °C			5	- μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			Α	
	_	$V_{GS} = 10 \text{ V}, I_D = 5.9 \text{ A}$		0.041	0.049	0	
Drain-Source On-State Resistance ^a	r _{DS(on)}	$V_{GS} = 6 \text{ V}, I_D = 5.5 \text{ A}$		0.048	0.060	Ω	
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, I_{D} = 5.9 \text{ A}$		14		S	
Diode Forward Voltage ^a	V_{SD}	$I_S = 2.9 \text{ A}, V_{GS} = 0 \text{ V}$		0.77	1.2	V	
Dynamic ^b	•		•	•	•		
Total Gate Charge	Q_g			16	24		
Gate-Source Charge	Q _{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 5.9 \text{ A}$		3.8		nC	
Gate-Drain Charge	Q _{gd}			5.5		1	
Gate Resistance	R_g			2.2		Ω	
Turn-On Delay Time	t _{d(on)}			15	25		
Rise Time	t _r	V_{DD} = 50 V, R_L = 50 Ω		15	25		
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ 1 A, V_{GEN} = 10 V, R_G = 6 Ω		35	55	ns	
Fall Time	t _f			20	30		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 2.9 A, di/dt = 100 A/μs		50	75		

- Notes a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless noted



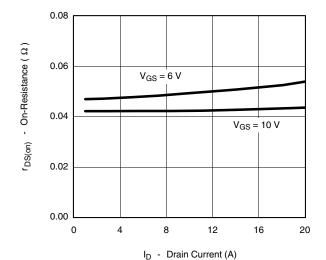




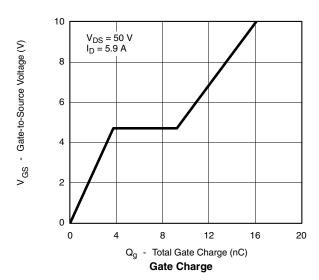


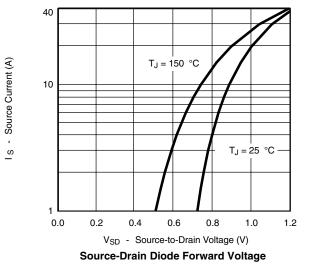


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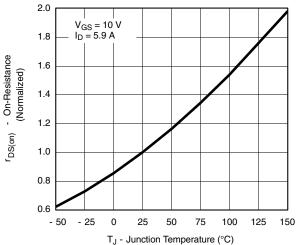
On-Resistance vs. Drain Current



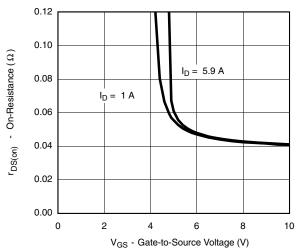


1500 1200 C - Capacitance (pF) C_{iss} 900 600 300 0 10 20 30 40 50 60 70 8(

V_{DS} - Drain-to-Source Voltage (V) **Capacitance**



On-Resistance vs. Junction Temperature

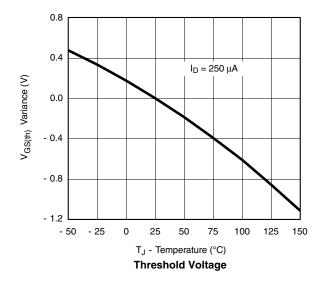


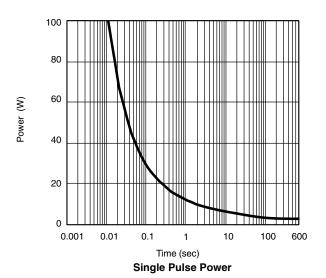
On-Resistance vs. Gate-to-Source Voltage

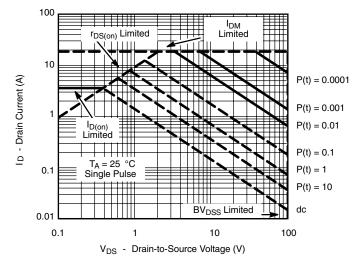
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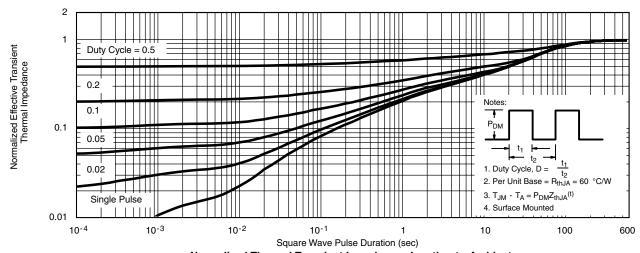
TYPICAL CHARACTERISTICS 25 °C, unless noted







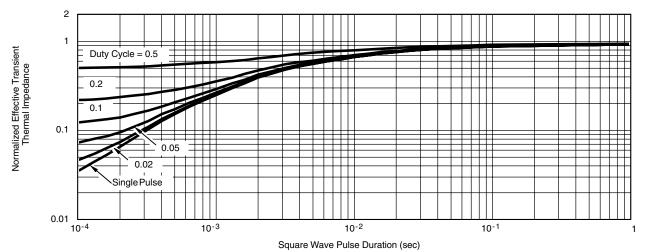
Safe Operating Area, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C, unless noted



Normalized Thermal Transient Impedance, Junction-to-Case

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